



GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 3.0 - 3.8 GHz

Typical Applications

The HMC333 / HMC333E is ideal for:

Wireless Local Loop

Features

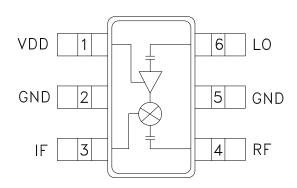
Integrated LO Amplifier w/ Pdiss: < 25 mW Conversion Loss / Noise Figure: 8.5 dB

Low LO Drive Level: 0 dBm

Input IP3: +10 dBm

Single Positive Supply: 3V to 5V

Functional Diagram



General Description

The HMC333 & HMC333E are single balanced mixer ICs with integrated LO amplifiers. This converter IC can operate as an upconverter or downconverter between 3.0 GHz and 3.8 GHz. With the integrated LO amplifier, the mixer requires an LO drive level of only 0 dBm, and requires only 7 mA from a single positive +3V rail. The mixer has 8.5 dB of conversion loss, an input P1dB of 0 dBm and an input third order intercept point of +10 dBm at 3.5 GHz.

Electrical Specifications, $T_A = +25^{\circ}$ C

Parameter	IF = 100 MHz LO = 0 dBm & Vdd = +3V			Units
	Min.	Тур.	Max.	
Frequency Range, RF & LO	3.0 - 3.8		GHz	
Frequency Range, IF	DC - 1.0		GHz	
Conversion Loss		8.5	11	dB
Noise Figure (SSB)		8.5	11	dB
LO to RF Isolation	10	15		dB
LO to IF Isolation	5	10		dB
RF to IF Isolation	10	15		dB
IP3 (Input)	3	10		dBm
1 dB Compression (Input)	-3	+1		dBm
Supply Current (Idd)		7		mA

^{*} Unless otherwise noted, all measurements performed as downconverter, IF= 100 MHz.

HMC333* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

COMPARABLE PARTS -

View a parametric search of comparable parts.

EVALUATION KITS

• HMC333 Evaluation Board

DOCUMENTATION

Data Sheet

• HMC333 Data Sheet

TOOLS AND SIMULATIONS

• HMC333 S-Parameter

REFERENCE MATERIALS 🖵

Quality Documentation

- HMC Legacy PCN: SOT26 and SOT26E packages -Relocation of pre-existing production equipment to new building
- Semiconductor Qualification Test Report: MESFET-F (QTR: 2013-00247)

DESIGN RESOURCES 🖵

- HMC333 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- · Symbols and Footprints

DISCUSSIONS

View all HMC333 EngineerZone Discussions.

SAMPLE AND BUY 🖵

Visit the product page to see pricing options.

TECHNICAL SUPPORT

Submit a technical question or find your regional support number.

DOCUMENT FEEDBACK

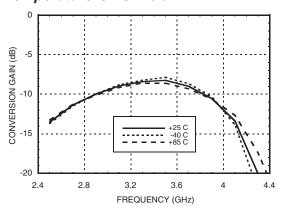
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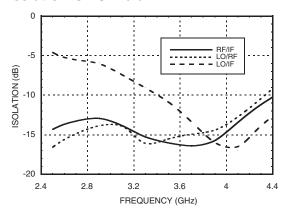




Conversion Gain vs. Temperature @ LO = 0 dBm



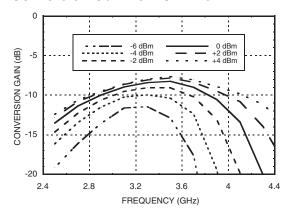
Isolation @ LO = 0 dBm



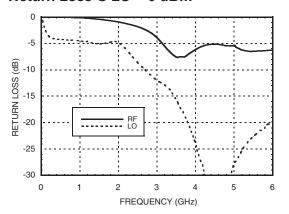
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LO AMPLIFIER, 3.0 - 3.8 GHz

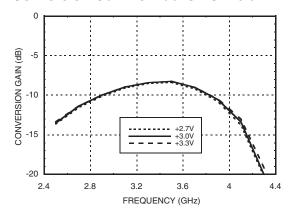
Conversion Gain vs. LO Drive



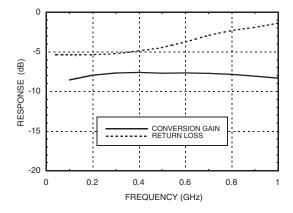
Return Loss @ LO = 0 dBm



Conversion Gain vs. Vdd @ LO = 0 dBm



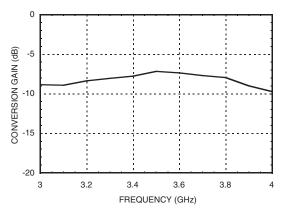
IF Bandwidth @ LO = 0 dBm



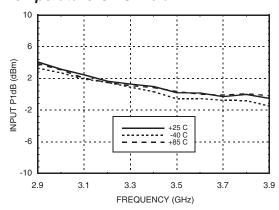




Upconverter Performance Conversion Gain @ LO = 0 dBm



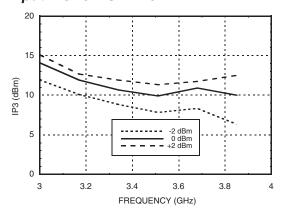
Input P1dB vs. Temperature @ LO = 0 dBm



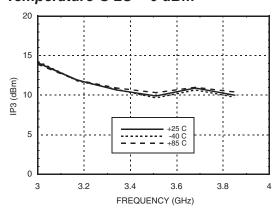
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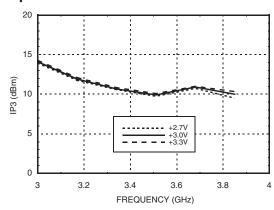
Input IP3 vs. LO Drive*



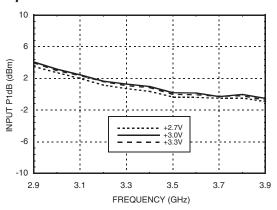
Input IP3 vs. Temperature @ LO = 0 dBm*



Input IP3 vs. Vdd @ LO = 0 dBm*



Input P1dB vs. Vdd @ LO = 0 dBm



^{*} Two-tone input power= -10 dBm each tone, 1 MHz spacing.





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MxN Spurious @ IF Port

	nLO				
mRF	0	1	2	3	4
0	xx	-9	-5	12	34
1	8	0	32	25	34
2	33	49	40	40	43
3	68	56	68	48	72
4	77	80	79	80	71

RF = 3.5 GHz @ -10 dBm

LO = 3.4 GHz @ 0 dBm

All values in dBc below IF power level.

Harmonics of LO

	nLO Spur @ RF Port			
LO Freq. (GHz)	1	2	3	4
3	12	8	16	49
3.17	13	8	20	39
3.34	17	10	22	42
3.51	15	14	26	48
3.68	14	17	25	42
3.85	14	18	22	43

LO = 0 dBm

All values in dBc below input LO level @ RF port.





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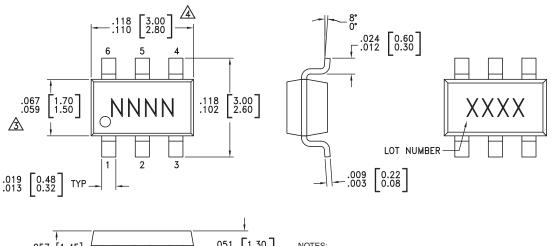
Absolute Maximum Ratings

RF / IF Input (Vdd = +3V)	+13 dBm	
LO Drive (Vdd = +3V)	+13 dBm	
Vdd	5.5V	
Continuous Pdiss (Ta = 85 °C) (derate 2.64 mW/°C above 85 °C)	238 mW	
IF DC Current	±3 mA	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	



ELECTROSTATIC SENSITIVE DEVICE **OBSERVE HANDLING PRECAUTIONS**

Outline Drawing



.051 [1.30] .035 [0.90] .057 [1.45] .0374 [0.95] TYP-0.15

NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- (3) DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC333	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H333 XXXX
HMC333E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	333E XXXX

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX





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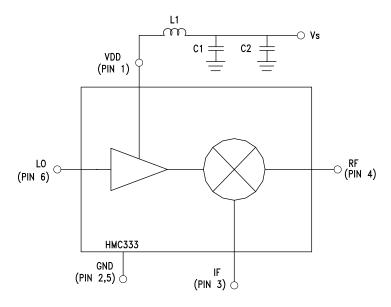
Pin Descriptions

Pin Number	Function	Description	Interface Schematic	
1	Vdd	Power supply for the LO Amplifier. Two external RF bypass capacitors (10 pF & 10,000 pF) and an external inductor (1.8 nH) are required.	Vdd O	
2, 5	GND	Ground: Pin must connect to RF ground.		
3	IF	This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source/sink more than 3mA of current or die nonfunction and possible die failure will result.	IFO	
4	RF	This pin is AC coupled and matched to 50 Ohm from 3.0 - 3.8 GHz.	RFO—	
6	LO	This pin is AC coupled and matched to 50 Ohm from 3.0 - 3.8 GHz	Vdd	



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Application Circuit



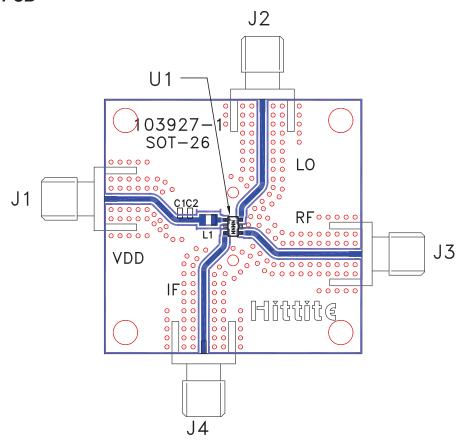
v01.0705





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Evaluation PCB



v01.0705

List of Materials for Evaluation PCB 105128 [1]

Item	Description	
J1 - J4	PCB Mount SMA RF Connector	
C1	10 pF Capacitor, 0603 Pkg.	
C2	.01 μF Capacitor, 0603 Pkg.	
L1	1.8 nH Inductor, 0805 Pkg.	
U1	HMC333 / HMC333E Mixer	
PCB [2]	103927 Evaluation Board	

^[1] Reference this number when ordering complete evaluation PCB $\,$

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

^[2] Circuit Board Material: Rogers 4350